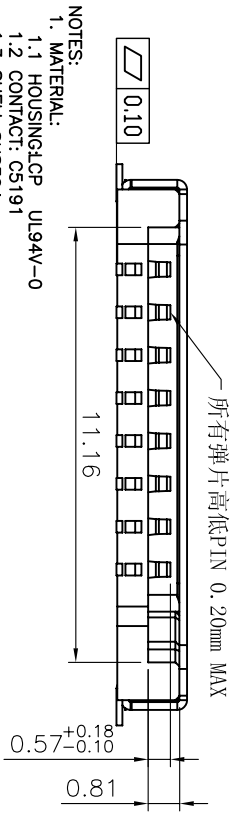
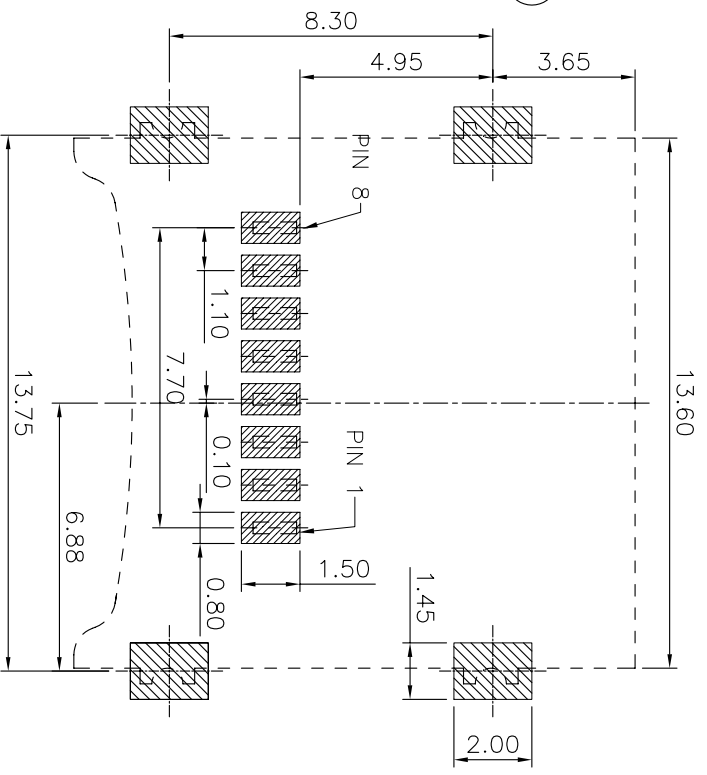
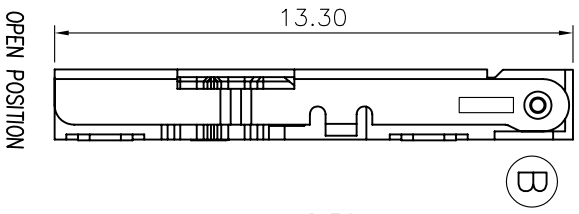
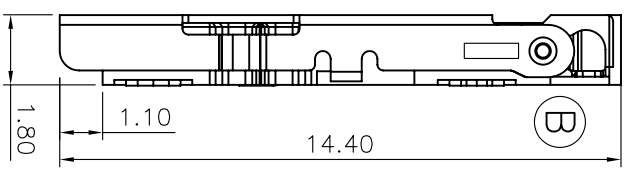
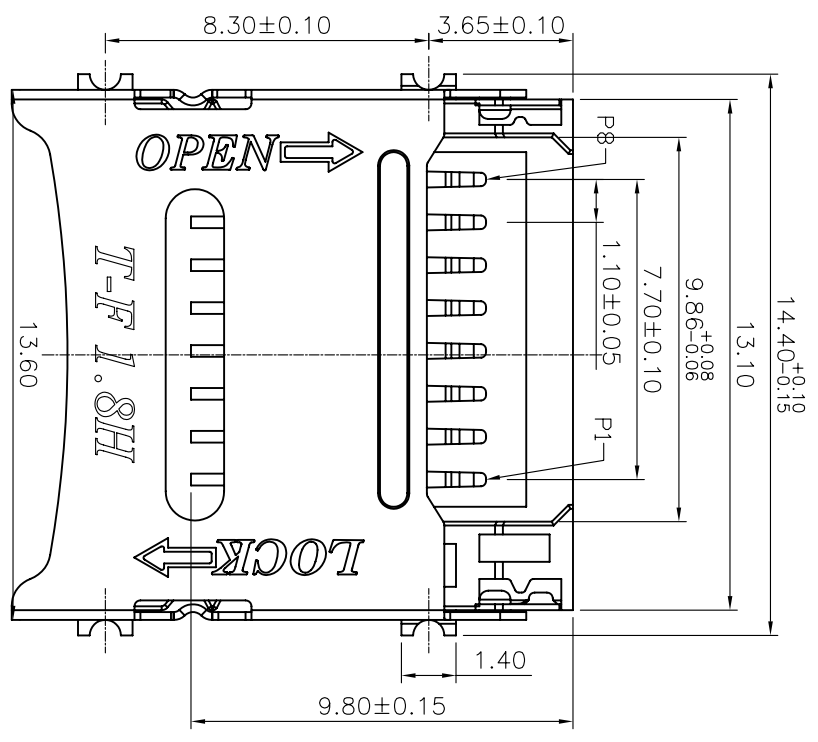


REV. A	DATE 2012/12/12	ECN NO. /	MODIFICATION NEW	APPROVER Vicky
REV. B	DATE 2015/09/22	ECN NO. RD00315092101	MODIFICATION 外壳变更, 详见“B”处	APPROVER Vicky



- NOTES:
- MATERIAL:
 - HOUSING: LCP UL94V-0
 - CONTACT: C5191
 - SHELL: SUS304
 - FINISH:
 - CONTACT: 1u"MIN. AU PLATED ON CONTACT AREA 100u"MIN MATTE TIN PLATING ON SOLDER TAIL AREA 50~80u" NICKEL UNDERPLATING OVERALL
 - SPECIALITY:
 - Rated Current: 1.0A
 - Rated Voltage: 30V
 - Contact Resistance: 50mΩ Max
 - Insulation Resistance: 100MΩ Min 100V DC
 - Dielectric Withstanding Voltage: 100V AC
 - Solder Ability: 245±5°C, 5±0.5s
 - Durability: 5000 cycles
 - Operating Condition: Temperature: -30°C~+80°C; Humidity: 80%RH Max

PIN 8	DATA
PIN 7	DATA
PIN 6	VSS
PIN 5	CLK
PIN 4	VDD
PIN 3	CMD
PIN 2	CD/DAT3
PIN 1	DAT2
PIN NO.	PIN ASSIGNMENT

GENERAL TOLERANCE		UNITS mm		NAME: MICRO SD	
SELECT	✓			PART NO: MR08C-06201	TITLE: MICRO SD CARD 掀盖 H=1.8
ON/TOL	1 2 3			APPD: Vicky	DWG NO. ATOM-A01682
X.XXX	±0.05 ±0.08 ±0.15			CHKD: Doris	SCALE 1:1
X.XX	±0.15 ±0.13 ±0.25			DR: Cmy	SHEET 1/1
X.X	±0.25 ±0.23 ±0.50				SHEET REV A
X.	±0.38 ±1.00				
ANGLE	±1°				